# SK 200 GD 066 T



SEMITOP<sup>®</sup>4

### 3-phase bridge inverter

#### SK 200 GD 066 T

Target Data

#### Features

- One screw mounting module
- Fully compatible with SEMITOP<sup>®</sup>1,2,3
- Improved thermal performances by aluminium oxide substrate
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

#### **Typical Applications**

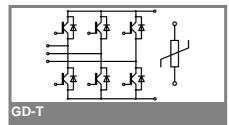
- Inverter up to 42 kVA
- Typ. motor power 18,5 kW

#### Remarks

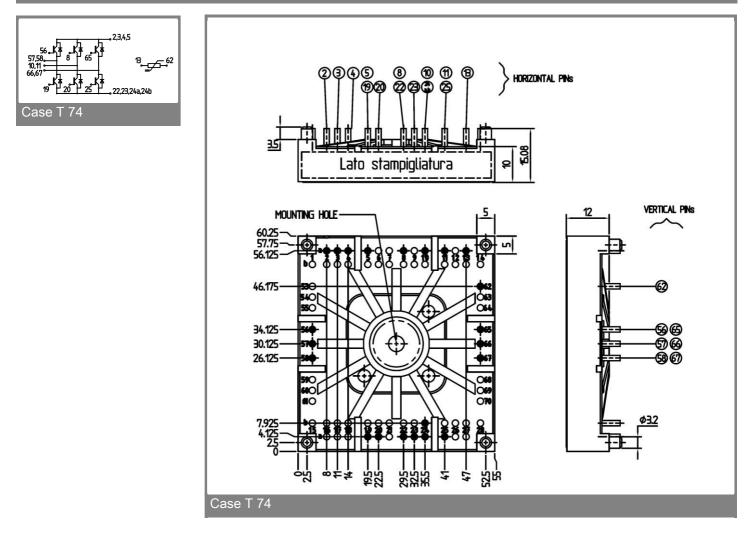
• V<sub>CE.sat</sub>, V<sub>F</sub> = chip level value

Absolute Maximum Ratings		$T_s = 25^{\circ}C$ , unless otherwise	$T_s = 25^{\circ}C$ , unless otherwise specified					
Symbol	Conditions	Values	Units					
IGBT - Inverter								
V <sub>CES</sub>		600	V					
I <sub>C</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>i</sub> = 150 °C	158 (109)	А					
I <sub>C</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>i</sub> = 175 °C	174 (131)	А					
I <sub>CRM</sub>	, t <sub>p</sub> = 1 ms	345	А					
V <sub>GES</sub>	r	± 20	V					
Т <sub>ј</sub>		-40 + 175	°C					
Diode - Inverter								
I <sub>F</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>i</sub> = 150 °C	91 (67)	А					
I <sub>F</sub>	T <sub>s</sub> = 25 (70) °C, T <sub>j</sub> = 175 °C	99 (79)	А					
I <sub>FRM</sub>	$I_{FRM} = 2 \times I_{Fnom}, t_p = ms$							
Т <sub>і</sub>		-40 + 175	°C					
T <sub>sol</sub>	Terminals, 10 s	260	°C					
T <sub>stg</sub>		-40 + 125	°C					
V <sub>isol</sub>	AC, 1 min.	2500	V					

Characte	ristics	T <sub>s</sub> = 25°C	$T_s = 25^{\circ}C$ , unless otherwise specified					
Symbol	Conditions	min.	typ.	max.	Units			
IGBT - Inverter								
V <sub>CE(sat)</sub>	I <sub>Cnom</sub> = 200 A, T <sub>j</sub> = 25 (125) °C		• •	1,9 (2,15)	V			
V <sub>GE(th)</sub>	$V_{GE} = V_{CE}, I_{C} = 3,2 \text{ mA}$	5	5,8	6,5	V			
V <sub>CE(TO)</sub>	T <sub>j</sub> = 25 (150) °C		0,6 (0,7)		V			
r <sub>CE</sub>	$T_{j} = 25 (150) \ ^{\circ}C$		2,75 (4,25)	4 (5,5)	mΩ			
C <sub>ies</sub>	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		-		nF			
C <sub>oes</sub>	$V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz$		-		nF			
C <sub>res</sub>	$V_{CE} = 25 V, V_{GE} = 0 V, f = 1 MHz$		-		nF			
R <sub>th(j-s)</sub>	per IGBT		0,45		K/W			
t <sub>d(on)</sub>	under following conditions		-		ns			
t <sub>r</sub>	$V_{CC} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$		-		ns			
t <sub>d(off)</sub>	$I_{Cnom} = 200 \text{ A}, T_j = 150 \text{ °C}$		-		ns			
t <sub>f</sub>	$R_{Gon} = R_{Goff} = 4 \Omega$		-		ns			
E <sub>on</sub> (E <sub>off</sub> )	inductive load		6,8 (7)		mJ			
Diode - Inverter								
$V_F = V_{EC}$	I <sub>F</sub> = 200 A, T <sub>i</sub> = 25 (150) °C		1,48 (1,5)		V			
V <sub>(TO)</sub>	T <sub>i</sub> = 25 (150) °C		0,95 (0,85)		V			
r <sub>T</sub>	T <sub>j</sub> = 25 (150) °C		3 (3,5)		mΩ			
R <sub>th(j-s)</sub>	per diode		0,8		K/W			
I <sub>RRM</sub>	under following conditions		-		Α			
Q <sub>rr</sub>	I <sub>Fnom</sub> = A, V <sub>R</sub> = V		-		μC			
E <sub>rr</sub>	$V_{GE} = 0 V, T_j = °C$				mJ			
	di <sub>F</sub> /dt = - A/µs							
Temperature Sensor								
R <sub>ts</sub>	5 %, T <sub>r</sub> = 25 (100) °C		5000(493)		Ω			
Mechanical Data								
w			60		g			
M <sub>s</sub>	Mounting torque		3,5		Nm			
		•						



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.